

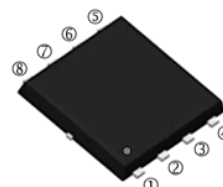
RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

DESCRIPTION

The SPR230N03S-C is the Shielded Gate Technology N-ch MOSFETs with extreme high cell density, which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications.

The SPR230N03S-C meet the RoHS and Green Product requirement with full function reliability approved.

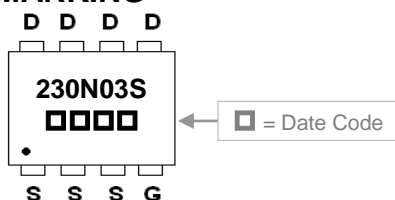
PR-8PP



FEATURES

- Shielded Gate Trench Technology
- Super Low Gate Charge
- Green Device Available

MARKING

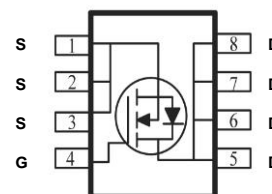


PACKAGE INFORMATION

Package	MPQ	Leader Size
PR-8PP	3K	13 inch

ORDER INFORMATION

Part Number	Type
SPR230N03S-C	Lead (Pb)-free and Halogen-free



ABSOLUTE MAXIMUM RATINGS ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^{1,4} @ $V_{GS}=10\text{V}$	I_D	$T_C=25^\circ\text{C}$	230
		$T_C=100^\circ\text{C}$	147
Pulsed Drain Current ²	I_{DM}	400	A
Power Dissipation ³	P_D	89	W
Operating Junction & Storage Temperature Range	T_J, T_{STG}	-55~150	$^\circ\text{C}$
Thermal Resistance Ratings			
Maximum Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	62	$^\circ\text{C/W}$
Maximum Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	1.4	

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ C$ unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	30	-	-	V	$V_{GS}=0V, I_D=250\mu A$	
Gate-Threshold Voltage	$V_{GS(th)}$	1	-	2.5	V	$V_{DS}=V_{GS}, I_D=250\mu A$	
Forward Transfer Conductance	g_{fs}	95	-	-	S	$V_{DS}=5V, I_D=20A$	
Gate-Source Leakage Current	I_{GSS}	-	-	± 100	nA	$V_{GS}=\pm 20V$	
Drain-Source Leakage Current	I_{DSS}	$T_J=25^\circ C$	-	-	1	uA	$V_{DS}=24V, V_{GS}=0V$
		$T_J=55^\circ C$	-	-	5		
Static Drain-Source On-Resistance ²	$R_{DS(ON)}$	-	0.9	1.2	m Ω	$V_{GS}=10V, I_D=20A$	
		-	1.3	1.7		$V_{GS}=4.5V, I_D=20A$	
Gate Resistance	R_g	-	1.4	-	Ω	$f=1MHz$	
Total Gate Charge (4.5V)	Q_g	-	65	-	nC	$I_D=20A$ $V_{DD}=20V$ $V_{GS}=10V$	
Total Gate Charge		-	128	-			
Gate-Source Charge		-	20	-			
Gate-Drain Change		-	28	-			
Turn-on Delay Time	$T_{d(on)}$	-	38	-	nS	$V_{DD}=20V$ $I_D=20A$ $V_{GS}=10V$ $R_G=1.5\Omega$	
Rise Time	T_r	-	22	-			
Turn-off Delay Time	$T_{d(off)}$	-	115	-			
Fall Time	T_f	-	150	-			
Input Capacitance	C_{iss}	-	7427	-	pF	$V_{GS}=0V$ $V_{DD}=15V$ $f=1MHz$	
Output Capacitance	C_{oss}	-	2930	-			
Reverse Transfer Capacitance	C_{rss}	-	538	-			
Source-Drain Diode							
Diode Forward Voltage ²	V_{SD}	-	-	1.2	V	$I_S=1A, V_{GS}=0V, T_J=25^\circ C$	
Continuous Source Current ^{1 4}	I_S	-	-	230	A	$V_G=V_D=0V, Force Current$	
Reverse Recovery Charge	Q_{rr}	-	114	-	nC	$I_F=20A, di/dt=100A/\mu s$	

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2oz copper.
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. The power dissipation is limited by 150°C junction temperature.
4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

CHARACTERISTIC CURVES

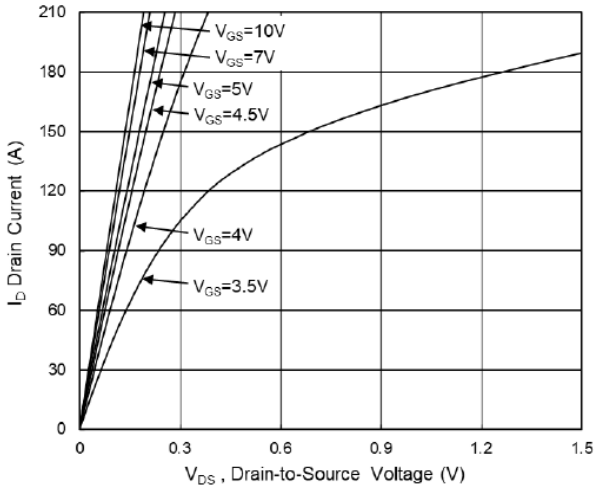


Fig.1 Typical Output Characteristics

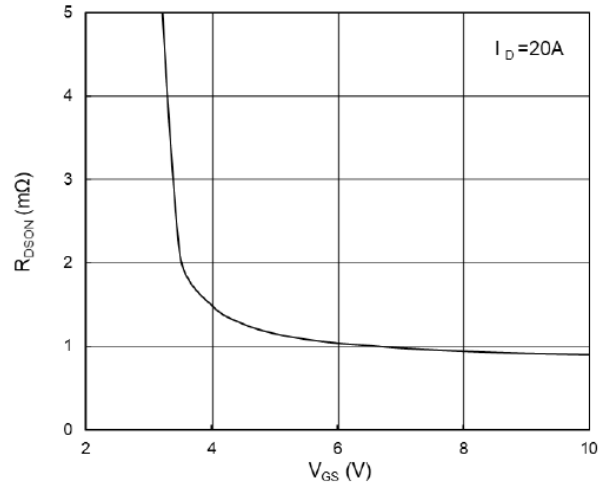


Fig.2 On-Resistance vs G-S Voltage

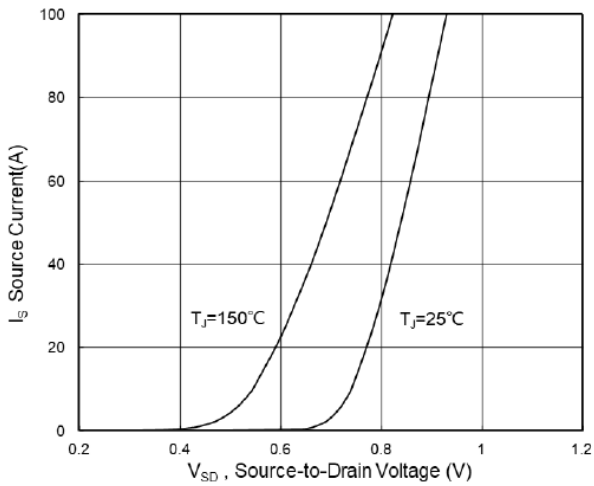


Fig.3 Source Drain Forward Characteristics

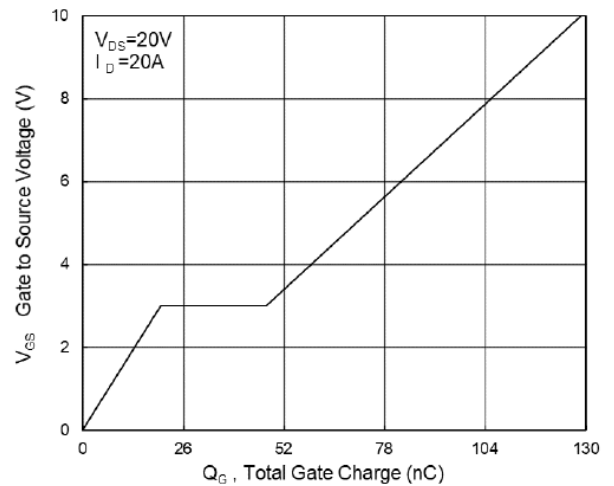


Fig.4 Gate-Charge Characteristics

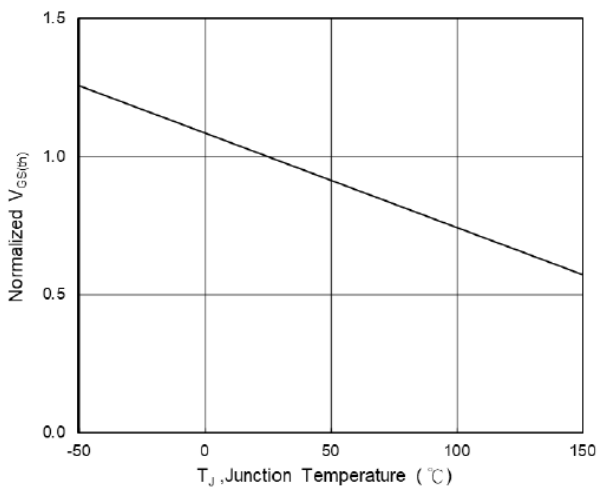


Fig.5 Normalized $V_{GS(th)}$ vs T_J

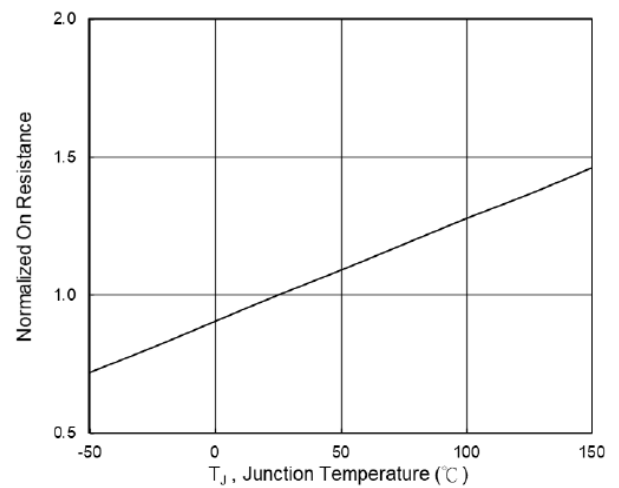


Fig.6 Normalized $R_{DS(on)}$ vs T_J

CHARACTERISTIC CURVES

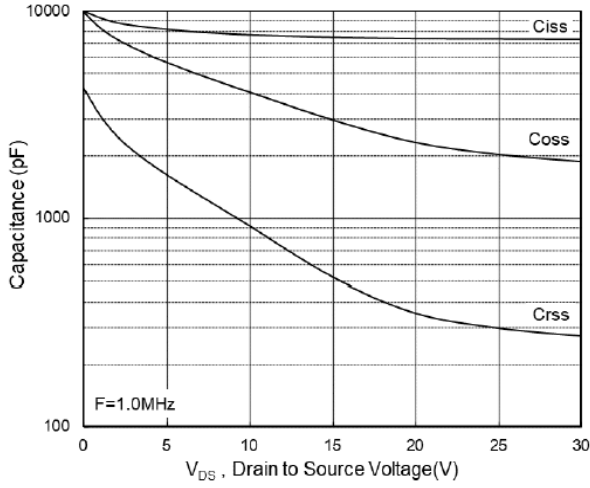


Fig.7 Capacitance

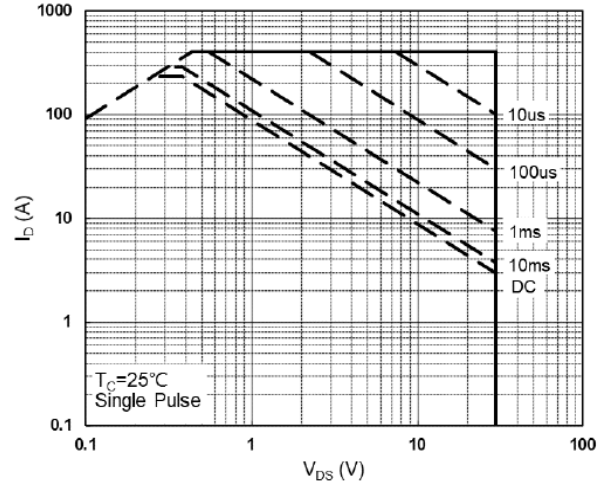


Fig.8 Safe Operating Area

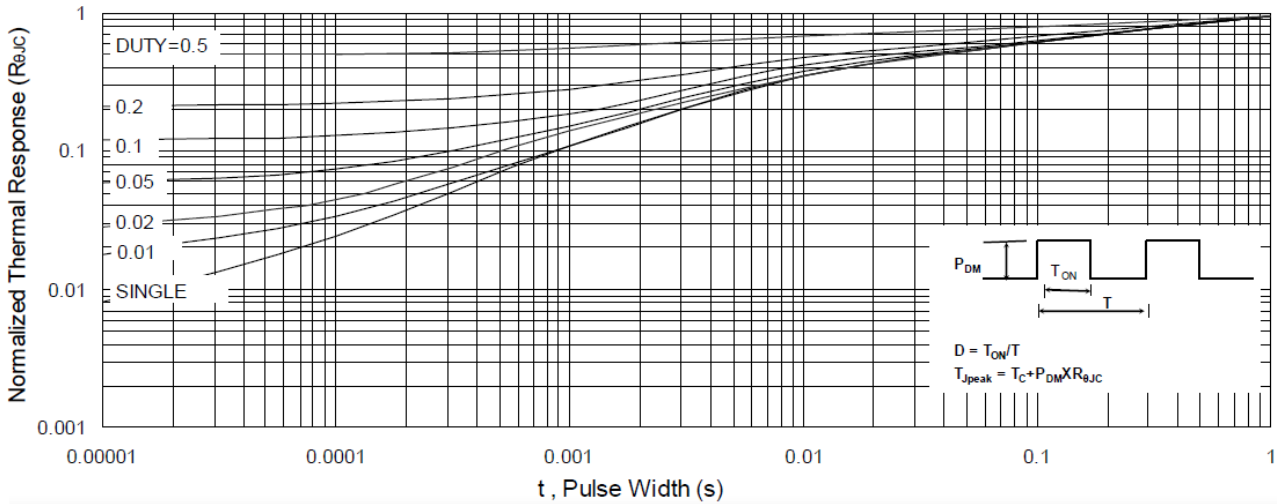


Fig.9 Normalized Maximum Transient Thermal Impedance

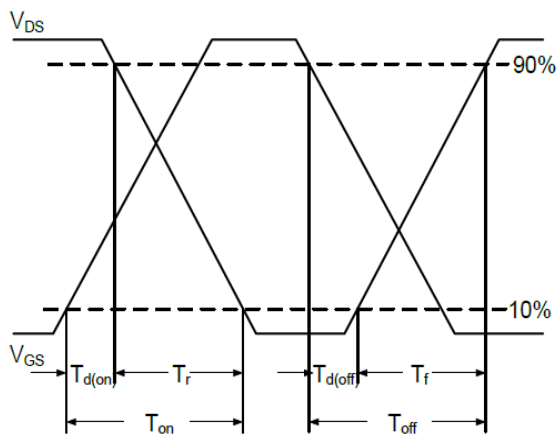


Fig.10 Switching Time Waveform

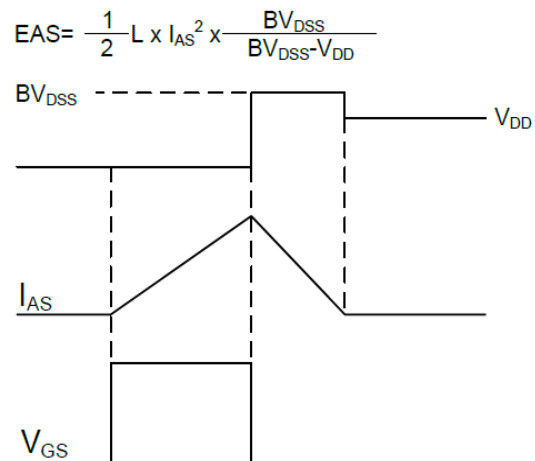
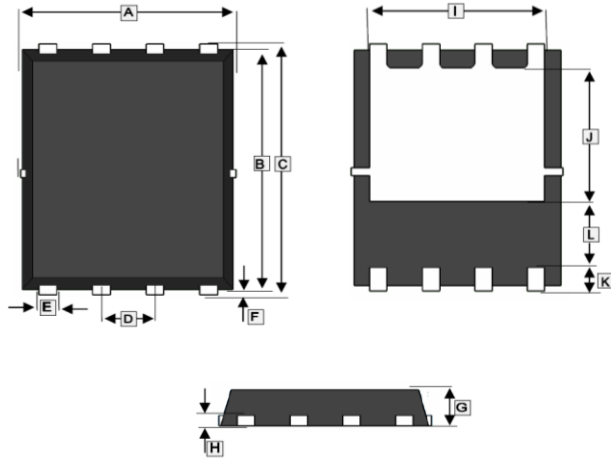


Fig.11 Unclamped Inductive Switching Waveform

PACKAGE OUTLINE DIMENSIONS

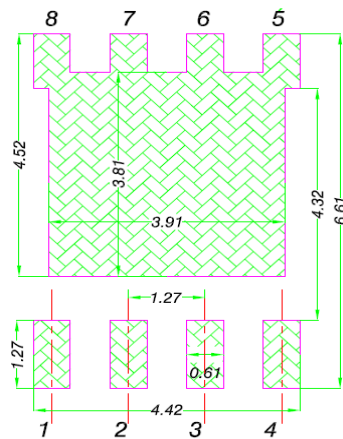
PR-8PP



REF.	Millimeter	
	Min.	Max.
A	4.90	5.10
B	5.70	5.90
C	5.90	6.20
D	1.27 BSC.	
E	0.33	0.51
F	0.06	0.20
G	0.80	1.10
H	0.254 REF.	
I	4.00 REF.	
J	3.40 REF.	
K	0.60 REF.	
L	1.40 REF.	

MOUNTING PAD LAYOUT

PR-8PP



*Dimensions in millimeters